



CONSTANT CURRENT LED DRIVER

FEATURES

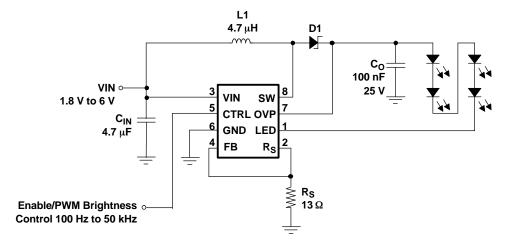
- Current Source with 18 V Overvoltage Protection
- Powers Up to 4 LEDs in Series
- Input Voltage Range . . 1.8 V to 6.0 V
- Internal 30 V Switch
- Up to 85% Efficiency
- Precise Brightness Control Using PWM Signal or Analog Signal
- Switching Frequency . . Up to 1 MHz
- Internal Power MOSFET Switch . . 400 mA
- Operates With Small Output Capacitors Down to 100 nF
- Disconnects LEDs During Shutdown
- No Load Quiescent Current . . 38 μA Typ
- Shutdown Current . . 0.1 μA Typ
- Available in a Small 3 mm × 3 mm QFN Package

APPLICATIONS

- White LED Supply for Display Backlight/Sidelight in
 - PDA, Pocket PC, Smart Phones
 - Handheld Devices
 - Cellular Phones

DESCRIPTION

The TPS61043 is a high frequency boost converter with constant current output that drives white LEDs or similar. The LED current is set with the external sense resistor (Rs) and is directly regulated by the feedback pin (FB) that regulates the voltage across the sense resistor R_S to 252 mV (typ). To control LED brightness, the LED current can be pulsed by applying a PWM (pulse width modulated) signal with a frequency range of 100 Hz to 50 kHz to the control pin (CTRL). To allow higher flexibility, the device can be configured where the brightness can be controlled by an analog signal as well, as described in the application information section. To avoid possible leakage currents through the LEDs during shutdown, the control pin (CTRL) disables the device and disconnects the LEDs from ground. For maximum safety during operation, the output has integrated overvoltage protection that prevents damage to the device by limiting the output voltage to typically 18 V in case of a high impedance output (e.g. faulty LED). The TPS61042 device provides a solution for applications where higher LED currents or more than four LEDs in series need to be powered.



A. Output capacitor values like 1 µF and larger, reduce the LED ripple current and improve line regulation.

Figure 1. Typical Application



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



ORDERING INFORMATION(1)

T _A	PACKAGE	PACKAGE MARKING
-40°C to 85°C	TPS61043DRB	AQN

⁽¹⁾ The DRB package is available taped and reeled. Add R suffix (TPS61043DRBR) to order quantities of 3000 devices per reel. Add T suffix (TPS61043DRBT) to order quantities of 250 devices per reel.

ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted)(1)

	TPS61043
Supply Voltages, v _(VIN) ⁽²⁾	-0.3 V to 7 V
Voltages, V _(Rs) , V _(CTRL) , V _(FB)	-0.3 V to Vin + 0.3 V
Voltages, V _(SW) , V _(LED) ⁽²⁾	30 V
Voltage, V _(OVP)	30 V
Continuous power dissipation	See Dissipation Rating Table
Operating junction temperature range	-40°C to 150°C
Storage temperature range, T _{STG}	-65°C to 150°C
Lead temperature (soldering, 10 sec)	260°C

⁽¹⁾ Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

DISSIPATION RATING

PACKAGE	THERMAL	T _A ≤ 25°C	DERATING FACTOR	T _A = 70°C	T _A = 85°C
	RESISTANCE	POWER RATING	ABOVE T _A = 25°C	POWER RATING	POWER RATING
8-pin QFN	$R_{\Theta JA} = 270^{\circ} \text{C/W}^{(1)}$	370 mW	3.7 mW/°C	204 mW	148 mW

⁽¹⁾ The thermal resistance junction to ambient of the 8-pin QFN package is measured with a standard 2-layer PCB without vias for the thermal pad.

RECOMMENDED OPERATING CONDITIONS

		MIN	NOM N	ΑX	UNIT
VI	Input voltage range	1.8		6.0	V
T _A	Operating ambient temperature	-40		85	°C
TJ	Operating junction temperature	-40		125	°C

ELECTRICAL CHARACTERISTICS

 $V_1 = 3.6 \text{ V}$, CTRL= V_1 , $T_A = -40 ^{\circ}\text{C}$ to + 85 $^{\circ}\text{C}$ typical values are at $T_A = 25 ^{\circ}\text{C}$ (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
SUPPLY	CURRENT	·	•			
V _I	Input voltage range		1.8		6.0	V
I _(Q)	Operating quiescent current into VIN	I _O = 0 mA, not switching		38	65	μA
I _{O(sd)}	Shutdown current	CTRL = GND		0.1	1	μA
V _{UVLO}	Under-voltage lockout threshold	V _I falling		1.5	1.7	V
CTRL		·	•			
V _{IH}	CTRL high level input voltage		1.3			V
V _{IL}	CTRL low level input voltage			•	0.3	V
I _{lkg}	CTRL input leakage current	CTRL = GND or VIN		•	0.1	μA
t _{on}	Minimim CTRL pulse witdh to enable	CTRL = low to high	500	•		us
t _{off}	Minimum CTRL pulse width to disable	CTRL = high to low	10		32	ms

⁽²⁾ All voltage values are with respect to network ground terminal.



ELECTRICAL CHARACTERISTICS (continued)

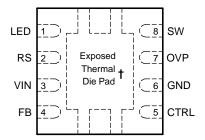
 $V_1 = 3.6 \text{ V}$, CTRL= V_1 , $T_A = -40^{\circ}\text{C}$ to + 85°C typical values are at $T_A = 25^{\circ}\text{C}$ (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f _(CTRL)	PWM switching frequency applied to CTRL		0.1		50	kHz
D _(CTRL)	PWM duty cycle applied to CTRL		1%		100%	
	WITCH AND CURRENT LIMIT (SW)					
V _S	Maximum switch voltage				30	V
r _{ds(ON)}	MOSFET on-resistance	$V_1 = 3.6 \text{ V}; I_{(SW)} = 200 \text{ mA}$		300	600	$m\Omega$
lkg	MOSFET leakage current	V _(SW) = 28 V		0.1	10	μA
LIM	MOFSET current limit		320	400	480	mA
T _{ON}	Power switch maximum on-time	V _O = 15 V		4.5		μs
T _{OFF}	Power switch minimum off-time			400		ns
LED SWIT	CH AND CURRENT LIMIT (LED)					
V _S	Maximum switch voltage				30	V
(LED)	Maximum LED switch current				60	mA
ds(ON)	MOSFET on-resistance	$V_1 = 3.6 \text{ V}; I_{SW} = 20 \text{ mA}$		1	2	Ω
lkg	MOSFET leakage current	V _(LED) = 28 V		0.1	10	μA
OUTPUT						
V _o	Output voltage range	OVP connected	V _I		16.9	V
(FB)	Feedback input bias current ⁽¹⁾	V _(FB) = 0.252 V			100	nA
V _{FB}	Feedback trip point voltage	1.8 V ≤ V _I ≤ 6.0 V	244	252	260	mV
V _(OVP)	Output overvoltage protection	V _O rising	17	18	19	V
V _{hys(OVP)}	Output overvoltage protection hysteresis			3.65		V
I _(OVP)	OVP input current	V _O = 15 V		17	23	μA

⁽¹⁾ The feedback input is high impedance MOSFET Gate input.

PIN ASSIGNMENT

DRB PACKAGE (TOP VIEW)



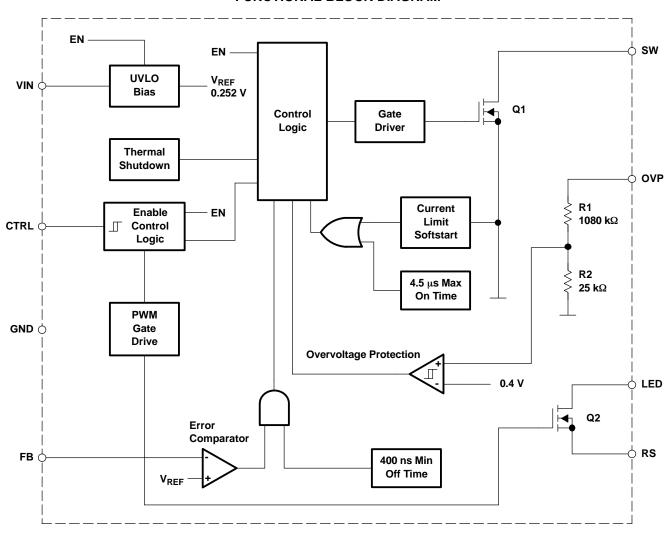
[†] The exposed thermal die pad is connected to GND.



Terminal Functions

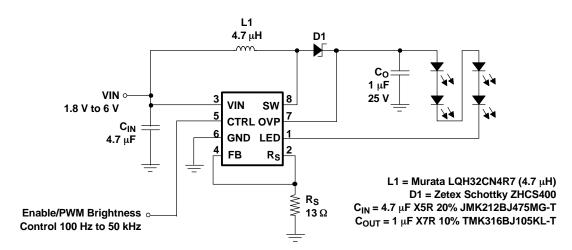
TERM	IINAL	1/0	DESCRIPTION
NAME	NO.	1/0	DESCRIPTION
CTRL	5	I	Combined enable and PWM control pin. If CTRL is constantly pulled high, the device is enabled and the internal LED switch (Q2) is constantly turned on. When CTRL is pulled to GND, the device is disabled. Apply a PWM signal (100 Hz to 50 kHz) to this pin to control the brightness of the LEDs
FB	4	ı	Feedback. FB regulates the LED current through the sense resistor by regulating the voltage across R_S to 252 mV.
GND	6		GND
LED	1	1	Input of the LED switch (Q2). Connect the LEDs to this pin.
OVP	7	1	Overvoltage protection. OVP is connected to the output capacitor of the converter.
RS	2	0	Output of the internal LED switch. The sense resistor that programs the LED current is connected to RS.
SW	8	ı	Drain of the integrated switch (Q1)
VIN	3	ı	Input supply pin.

FUNCTIONAL BLOCK DIAGRAM





TYPICAL CHARACTERISTICS





TYPICAL CHARACTERISTICS

Table of Graphs

			FIGURE
η	Efficiency	vs LED current	Figure 2
		vs Input voltage	Figure 3
IQ	Operating Quiescent Current into VIN	vs Input voltage and Temperature	Figure 4
V _(FB)	Feedback voltage	vs Temperature	Figure 5
I _(FB)	Feedback current	vs Temperature	Figure 6
r _{ds(on)}	Main switch Q1	vs Temperature	Figure 7
		vs Input voltage	Figure 8
	LED switch Q2	vs Temperature	Figure 9
		vs Input voltage	Figure 10
I _{LED}	Average LED current	vs PWM duty cycle on CTRL pin	Figure 11
	Soft start		Figure 12
	PFM operation (fixed peak current control)		Figure 13
	Burst mode operation (fixed peak current control)		Figure 14
	PWM dimming		Figure 15

Efficiency vs LED Current

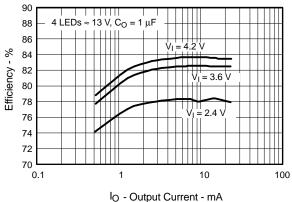


Figure 2.

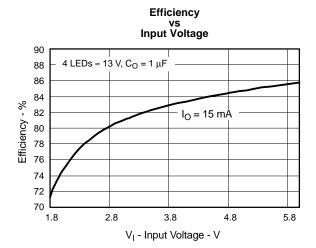
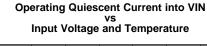


Figure 3.





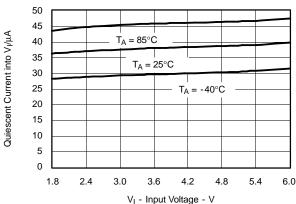


Figure 4.

Feedback Current

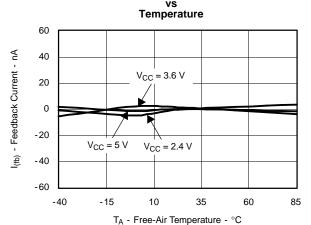


Figure 6.

r_{ds(ON)} Main Switch (Q1) Vs Input Voltage

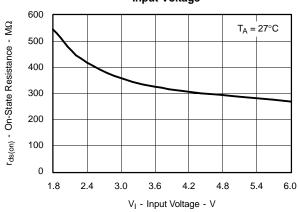


Figure 8.

Feedback Voltage vs Temperature

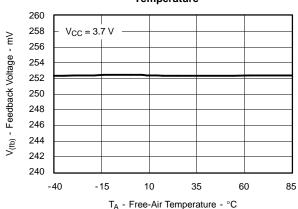


Figure 5.

r_{ds(on)} Main Switch (Q1) vs

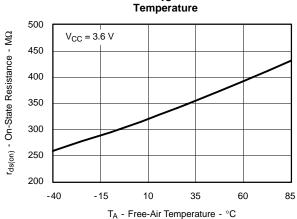


Figure 7.

r_{ds(on)} LED Switch (Q2) vs Temperature

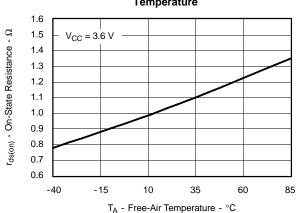
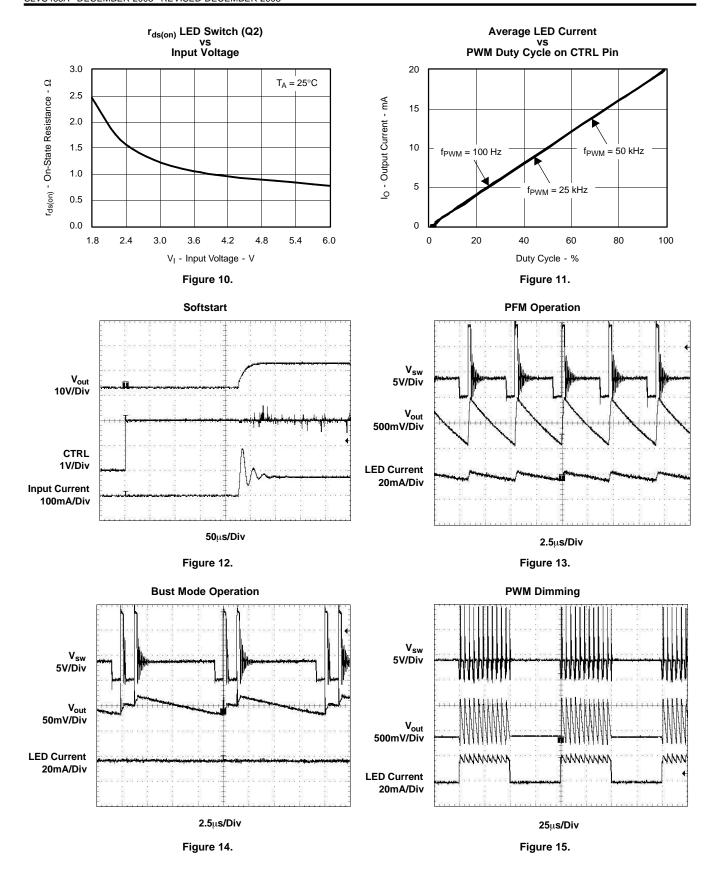


Figure 9.







DETAILED DESCRIPTION

Operation

The TPS61043 operates like a standard boost converter but regulates the voltage across the sense resistor ($R_{\rm S}$) instead of the output voltage. This gives an accurate regulated LED current independent of the input voltage and number of LEDs connected. With integrated overvoltage protection (OVP) the TPS61043 is configured as a current source with overvoltage protection ideally suited to drive LEDs. The device can generate output voltages of up to 16.9 V if the OVP-function is used and has an internal 400 mA MOSFET switch (Q1). This allows up to four LEDs to be connected in series to the output. The internal LED switch (Q2) in series with the LEDs has a maximum current rating of 60 mA and disconnects the LEDs from ground during shutdown. The LED switch is driven by a PWM signal applied to the control pin (CTRL), which directly controls the LED brightness. With this control method the LED brightness depends on the PWM duty cycle only and is independent of the PWM frequency and amplitude. If the OVP-function is not needed, the device can be used to generate output voltages up to 28V.

Boost Converter

The boost converter operates in a pulse frequency modulation (PFM) scheme with constant peak current control. This control scheme maintains high efficiency over the entire load current range and with a switching frequency of up to 1 MHz, enables the use of small external components. The converter monitors the sense voltage across R_S with the feedback pin (FB) and, when the feedback voltage falls below the reference voltage (252 mV typ), the main switch turns on and the current ramps up. The main switch turns off when the inductor current reaches the internally set peak current of 400 mA (typ). Refer to the *peak current control* section for more information. The second criteria that turns off the main switch is the maximum on-time of 4.5 μ s (typ). This limits the maximum on-time of the converter in extreme conditions. As the switch is turned off the external Schottky diode is forward biased, delivering the stored inductor energy to the output. The main switch remains off until the minimum off time of 400 ns (typ) has passed and the feedback voltage is below the reference voltage again. Using this PFM peak current control scheme, the converter operates in discontinuous conduction mode (DCM) where the switching frequency depends on the inductor, input and output voltage, and LED current. Lower LED currents reduce the switching frequency, which results in high efficiency over the entire LED current range. This regulation scheme is inherently stable, allowing a wide range for the selection of the inductor and output capacitor.

Peak Current Control (Boost Converter)

The internal switch is turned on until the inductor current reaches the DC current limit (I_{LIM}) of 400 mA (typ) . Due to the internal current limit delay of 100 ns (typ) the actual current exceeds the DC current limit threshold by a small amount. The typical peak current limit can be calculated:

$$I_{P(typ)} = I_{(LIM)} + \frac{V_I}{L} \times 100 \text{ ns}$$

$$I_P = 400 \text{ mA} + \frac{V_I}{L} \times 100 \text{ ns}$$

The higher the input voltage and the lower the inductor value, the greater the current limit overshoot.

Softstart

All inductive step-up converters exhibit high in-rush current during start-up if no special precautions are taken. This can cause voltage drops at the input rail during start-up, which may result in an unwanted or premature system shutdown.

The TPS61043 limits this in-rush current during start-up by increasing the current limit in two steps starting from $I_{LIM}/4$ for 256 switch cycles to $I_{LIM}/2$ for the next 256 switch cycles and then full current limit. See Figure 12 for typical start-up behavior.



Control (CTRL)

The CTRL pin serves two functions. One is the enable and disable of the device. The other is the PWM control of the internal LED switch (Q2). The CTRL pin can be used as a standard enable pin for the device if no PWM signal is applied to the CTRL pin. To enable the device, the CTRL pin must be pulled high for a time period of at least 500 µs. The device starts with the Softstart cycle. Pulling the CTRL pin to GND for a time period ≥32 ms disables the device, disconnecting the LEDs from GND by opening the LED switch (Q2) to avoid any LED leakage current. See Figure 16 for the CTRL pin timing.

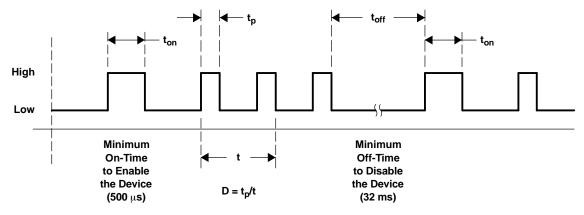


Figure 16. CTRL Timing Diagram

To enable the device, the CTRL signal must be high for 500 μ s (see Figure 16). The PWM signal can then be applied with a pulse width (t_p) greater or smaller than t_{ON} . To force the device into shutdown mode, the CTRL signal must be low for at least 32 ms. Requiring the CTRL pin to be low for 32 mS before the device enters shutdown allows for PWM dimming frequencies as low as 100 Hz. The device is enabled again when a CTRL signal is high for a period of 500 μ s minimum. See Figure 11 for the PWM duty cycle versus LED current characteristic.

The internal LED switch (Q2) is driven by the PWM signal when applied to the CTRL pin. Applying a PWM signal in the range of 100 Hz to 50 kHz allows the LED current to be pulsed with the duty cycle of the PWM signal. The CTRL pin accepts a PWM duty cycle from D = 1% to 100%. Duty cycles below 1% are also possible with the restriction that the device is forced into shutdown as the off time of the applied PWM signal exceeds 10 ms.

When a PWM signal is applied to the CTRL pin the LED switch (Q2) turns on immediately. The internal error comparator is disabled for 400 ns. This 400 ns delay time is required to establish the correct voltage level across the sense resistor R_S after the LED switch (Q2) is closed.

To achieve good LED current accuracy and linearity, the switching frequency of the converter must be higher than the PWM frequency applied to the CTRL pin. This CTRL pin must be terminated.

Overvoltage Protection (OVP)

As with any current source, the output voltage rises as the output impedance increases as for example with a disconnected load. To prevent the output voltage from exceeding the maximum main switch (Q1) voltage rating, an overvoltage protection (OVP) circuit is integrated. With an OVP threshold voltage of 19 V maximum, up to 4 LEDs can be connected in series. This allows the use of a cheaper output capacitor with a 25 V voltage rating. When the output voltage exceeds the OVP threshold voltage, (Q1) turns off. The converter switch remains off until the output voltage falls below the OVP threshold voltage. As long as the output voltage is below the OVP threshold the converter continues its normal operation, until the output voltage exceeds the OVP threshold again. If overvoltage protection is not needed, then the OVP pin should be connected to GND. In this case the TPS61043 can be used to generate output voltages up to 28V.



Undervoltage Lockout

An undervoltage lockout feature prevents mis-operation of the device at input voltages below 1.5 V (typ). As long as the input voltage is below the undervoltage threshold the device remains off, with the main MOSFET switch (Q1) and the LED switch (Q2) open.

Thermal Shutdown

An internal thermal shutdown is implemented in the TPS61043 that shuts down the device if the typical junction temperature of 160°C is exceeded. If the device is in thermal shutdown mode, the main MOSFET switch (Q1) and the LED switch (Q2) are open.

Inductor Selection, Maximum Load Current, and Switching Frequency

The PFM peak current control scheme of the TPS61043 is inherently stable. The inductor value does not affect the stability of the regulator. The selection of the inductor together with the nominal LED current, input, and output voltage of the application determines the switching frequency of the converter.

The first step is to calculate the maximum load current the converter can support using the selected inductor. The inductor value has less effect on the maximum available load current and is only of secondary order. A good inductor value to start with is $4.7~\mu H$. Depending on the application, inductor values down to $1.0~\mu H$ can be used. The maximum inductor value is determined by the maximum on time of the switch of $4.5~\mu s$ (typ). The peak current limit of 400~m A (typ) must be reached within this $4.5~\mu s$ for proper operation. The maximum load current of the converter is determined at the operation point where the converter starts to enter the continuous conduction mode. The converter must always operate in discontinuous conduction mode to maintain regulation.

Depending on the time period of the inductor current fall time being larger or smaller compared to the minimum off time of the converter (400 ns typ), the maximum load current can be calculated.

Inductor fall time:

$$t_f = \frac{I_p \times L}{V_O - V_I}$$

for $t_f \ge 400 \text{ ns}$

$$I_{LOAD \text{ (max)}} = \eta \times \frac{I_{P} \times V_{I}}{2 \times V_{O}}$$

for $t_f \le 400 \text{ ns}$

LOAD (max) =
$$\eta \times \frac{I_P^2 \times L \times V_I}{\left(V_O - V_I\right) \times \left(2 \times I_P \times L + 2 \times 400 \text{ ns} \times V_I\right)}$$

with:

L = selected inductor value

η = expected converter efficiency. Typically between 70% to 85%

$$I_{p} = 400 \text{ mA} + \frac{V_{l}}{L} \times 100 \text{ ns}$$
 (Peak inductor current as described in the *peak current control* section)

The above formula contains the expected converter efficiency that allows calculating the expected maximum load current the converter can support. The efficiency can be taken out of the efficiency graphs shown in Figure 2 and Figure 3 or 80% can be used as an accurate estimation.

If the converter can support the desired LED current, the next step is to calculate the converter switching frequency at the operation point, which must be ≤1 MHz. Also the converter switching frequency should be much higher than the applied PWM frequency at the CTRL pin to avoid non-linear brightness control. Assuming the converter shows no double pulses or pulse bursts (Figure 13 and Figure 14) on the switch node (SW) the switching frequency at the operation point can be calculated as:



$$f_{S} = \frac{2 \times I_{O} \times \left(V_{O} - V_{I} + V_{F}\right)}{\left(I_{LIM} + \frac{V_{I}}{2} \times 100 \text{ ns}\right)^{2} \times L} \leq 1MHz$$

with:

 $I_{LIM(min)}$ = minimum switch current limit (320 mA typ)

L = selected inductor value

I_O = nominal load or LED current

V_F = Rectifier diode forward voltage (typically 0.3 V)

The smaller the inductor value, the higher the switching frequency of the converter but the lower the efficiency. The selected inductor must have a saturation current that meets the maximum peak current of the converter as calculated in the *peak current control* section. Use the maximum value for I_{LIM} (480 mA) for this calculation. Another important inductor parameter is the DC resistance. The lower the DC resistance the higher the efficiency of the converter. See Table 1 and Figure 22 to Figure 26 for a selection of inductors.

INDUCTOR VALUE COMPONENT SUPPLIER SIZE 10 µH muRata LQH43CN100K01 4,5 mm×3,2 mm×2.6 mm $4.7 \mu H$ muRata LQH32CN4R7M11 3,2 mm×2,5 mm×2,0 mm 5,5 mm ×4,1 mm ×1,8 mm 10 µH Coilcraft DO1605T-103MX $4.7 \mu H$ Sumida CDRH3D16-4R7 3,8 mm×3,8 mm×1,8 mm Sumida CMD4D11-3R3 3,5 mm×5,3 mm×1,2 mm $3.3 \mu H$ 4.7 µH Sumida CMD4D11-4R7 3,5 mm×5,3 mm×1,2 mm Sumida CMD4D11-3R3 3.3 µH 3,5 mm×5,3 mm×1,2 mm 4.7 µH Coiltronics SD12-4R7 5,2 mm×5,2 mm×1,2 mm 3.3 µH Coilcraft LPO1704-332M 6,6 mm×5,5 mm×1,0 mm Coilcraft LPO1704-472M 6,6 mm×5,5 mm×1,0 mm 4.7 µH

Table 1. Possible Inductors (or equivalent)

Output Capacitor Selection and Line Regulation

For better output voltage filtering, a low ESR output capacitor is recommended. Ceramic capacitors have a low ESR value, but depending on the application, tantalum capacitors can be used.

The selection of the output capacitor value directly influences the output voltage ripple of the converter which also influences line regulation. The larger the output voltage ripple, the larger the line regulation, which means that the LED current changes if the input voltage changes. If a certain change in LED current gives a noticeable change in LED brightness, depends on the LED manufacturer and on the application. Applications requiring good line regulation $\leq 1\%$ /V (typ) must use output capacitor values $\geq 1~\mu$ F.

See Table 2 and Figure 22 to Figure 26 for the selection of the output capacitor.

Assuming the converter does not show double pulses or pulse bursts (see Figure 13 and Figure 14) on the switch node (SW), the output voltage ripple is calculated as:

 C_{O}



DETAILED DESCRIPTION (continued)

$$\Delta V_{O} = \frac{I_{O}}{C_{O}} \times \left[\frac{1}{f_{S}} - \frac{\left(I_{LIM(min)} + \frac{V_{I}}{2} \times 100 \text{ ns}\right) \times L}{V_{O} + V_{F} - V_{I}} \right] + I_{P} \times ESR$$

with:

I_{LIM(min)} = minimum switch current limit (320 mA typ)

L = selected inductor value

I_O = nominal load current

 f_S = switching frequency at the nominal load current as calaculated with equation (5).

25 V

V_F = rectifier diode forward voltage (0.3 V typ)

C_O = selected output capacitor

ESR = output capacitor ESR value

Input Capacitor Selection

For good input voltage filtering, low ESR ceramic capacitors are recommended. A 4.7 μ F ceramic input capacitor is sufficient for most applications. For better input voltage filtering the capacitor value can be increased. Refer to Table 2 and Figure 22 to Figure 26 for input capacitor selection.

CAPACITOR VOLTAGE RATING COMPONENT SUPPLIER COMMENTS 4.7 µF/X5R/0805 Tayo Yuden JMK212BY475MG 6.3 V C_{l} 10 µF/X5R/0805 6.3 V Tayo Yuden JMK212BJ106MG C_{l} 100 nF Any C_{O} 220 nF Any C_{O} 470 nF Any C_{O} 1.0 µF/X7R/1206 25 V Tayo Yuden TMK316BJ105KL C_{O} 1.0 µF/X7R/1206 35 V Tayo Yuden GMK316BJ105KL C_{O}

Table 2. Possible Input and Output Capacitors (or equivalent)

Diode Selection

4.7 µF/X5R/1210

To achieve high efficiency a Schottky diode must be used. The current rating of the diode must meet the peak current rating of the converter as it is calculated in the *peak current control* section. Use the maximum value for I_{LIM} for this calculation. See Table 3 and Figure 22 to Figure 26 for the Schottky diode selection.

Tayo Yuden TMK325BJ475MG

Table 3. Possible Diodes (or equivalent)

COMPONENT SUPPLIER	REVERSE VOLTAGE
ON Semiconductor MBR0530	30 V
ON Semiconductor MBR0520	20 V
Toshiba CRS02	30 V
Zetex ZHCS400	40 V



Efficiency

The overall efficiency of the application depends on the specific application conditions and mainly on the selection of the inductor. A lower inductor value increases the switching frequency and switching losses yielding in a lower efficiency. A lower inductor dc resistance has lower copper losses, giving a higher efficiency. Therefore, the efficiency can typically vary $\pm 5\%$ depending on the selected inductor. Figure 2 and Figure 3 can be used as a guideline for the application efficiency. These curves show the typical efficiency powering four LEDs using a 4.7 μ H inductor with just 1,2 mm height. The efficiency curve in Figure 2 and Figure 3 show the efficiency delivering the power to the LEDs rather than the overall converter efficiency and is calculated as:

$$\eta = \frac{V_{LED} \times I_{LED}}{V_{I} \times I_{I}}$$

Setting the LED Current

The converter regulates the LED current by regulating the voltage across the current sense resistor (R_S). The voltage across the sense resistor is regulated to the internal reference voltage of $V_{(FB)} = 252$ mV.

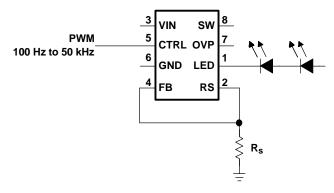


Figure 17. Setting the LED Current

The LED current can be calculated:

$$I_{LED} = \frac{V_{FB}}{R_{S}} = \frac{0.252 \text{ V}}{R_{S}}$$

The current programming method is used when the brightness of the LEDs is fixed or controlled by a PWM signal applied to the CTRL pin. When using a PWM signal on the CTRL pin, the LED brightness is only dependent on the PWM duty cycle, independent of the PWM frequency, or amplitude, which simplifies the system.

Analog Control Signal for Brightness Control

Alternatively, an analog voltage can be used as well to control the LED brightness.



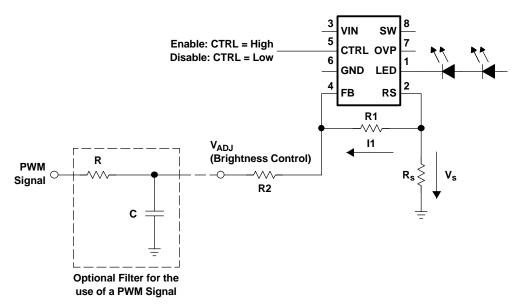


Figure 18. Setting the LED Current using an analog control signal

In Figure 18 the LED current is determined by the voltage applied to R2 (V_{ADJ}) and the selection of R1, R2 and the sense resistor (R_S). In this configuration, the LED current is linear controlled instead of pulsed as in the configuration before. To select the resistor values following steps are required.

- 1. Select the voltage V_{ADJ(max)} to turn the LEDs off, e.g. 3.3 V
- 2. Select the voltage V_{ADJ(min)} to turn the LEDs fully on, e.g. 0.0 V
- 3. Select the maximum and minimum LED current $I_{O(max)}$ and $I_{O(min)}$, e.g. $I_{O(max)} = 20$ mA, $I_{O(min)} = 0$ mA
- 4. Calculate R2 to achieve a feedback current in the range of $I_1 = 3 \mu A$ to 10 μA as the LEDs are fully turned on:

$$R2 = \frac{V_{ref} - V_{ADJ(min)}}{I_1}$$

5. Calculate R1

$$R1 = V_{ref} \times \frac{I_{O(max)} \times R2 + V_{ADJ(min)} - I_{O(min)} \times R2 - V_{ADJ(max)}}{V_{ADJ(max)} \times I_{O(max)} + V_{ref} \times I_{O(min)} - V_{ADJ(min)} \times I_{O(min)} - V_{ref} \times I_{O(max)}}$$

- 6. Calculate the sense voltage $(V_S)^{\text{ef}} \times \left(1 + \frac{R1}{R^2}\right) \frac{R1}{R^2} \times V$
- 7. Calculate the required sense resistor (R_S)

$$R_S = \frac{V_S}{I_{O(max)}}$$

PWM Control With Separate Enable

The control pin (CTRL) combines the enable function as well as the PWM brightness control function in one pin. For some systems an independent enable function is required. One way to implement this is to use the brightness control configuration as shown in the previous section Figure 18.

Other possible solutions are shown in Figure 19, Figure 20, Figure 21.



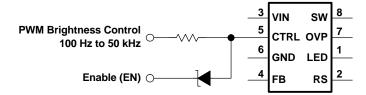


Figure 19. Separate Enable and PWM Control Using a Schottky Diode

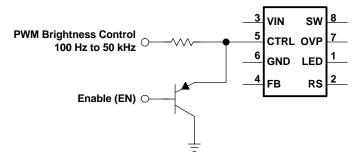


Figure 20. Separate Enable and PWM Control Using a Transistor

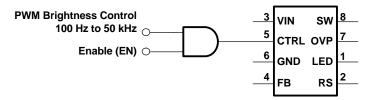


Figure 21. Separate Enable and PWM Control Using an AND Gate

Layout Considerations

In all switching power supplies the layout is an important step in the design, especially at high peak currents and switching frequencies. If the layout is not carefully done, the regulator might show noise problems and duty cycle jitter.

The input capacitor should be placed as close as possible to the input pin for good input voltage filtering. The inductor and diode must be placed as close as possible to the switch pin to minimize noise coupling into other circuits. It is important to connect the output capacitor directly across the diode cathode pin and ground rather than connecting the output capacitor across the LEDs. This minimizes EMI. Since the feedback pin and network is a high impedance circuit, the feedback network should be routed away from the inductor.

Thermal Considerations

The TPS61043 comes in a thermally enhanced QFN package. The package includes a thermal pad improving the thermal capabilities of the package. See the QFN/SON PCB Attachment application note (SLUA271).

The thermal resistance junction to ambient $R_{\Theta JA}$ of the QFN package greatly depends on the PCB layout. Using thermal vias and wide PCB traces improves the thermal resistance $R_{\Theta JA}$. Under normal operation conditions no PCB vias are required for the thermal pad. However, the thermal pad must be soldered to the PCB.



APPLICATION INFORMATION

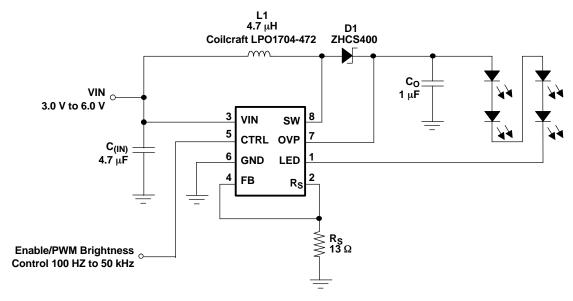


Figure 22. TPS61043 With 1,0 mm Total System Height

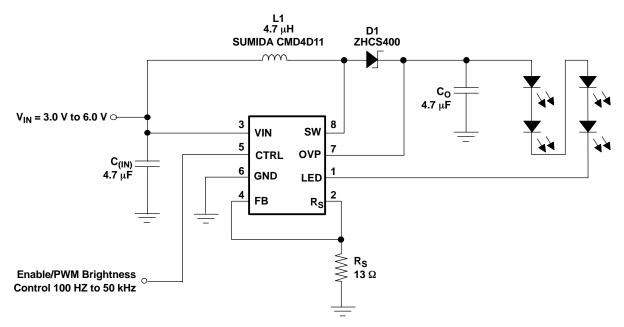


Figure 23. TPS61043 With Low LED Ripple Current and Higher Accuracy Using a 4.7 µF Output Capacitor



Application Information (continued)

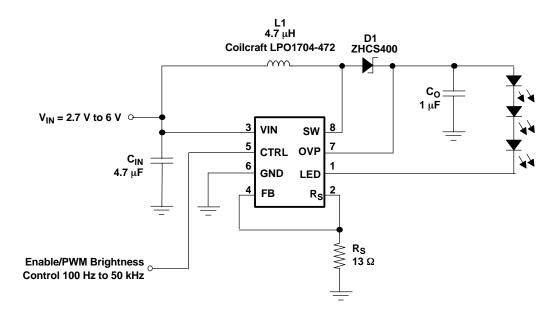


Figure 24. TPS61043 Powering 3 LEDs

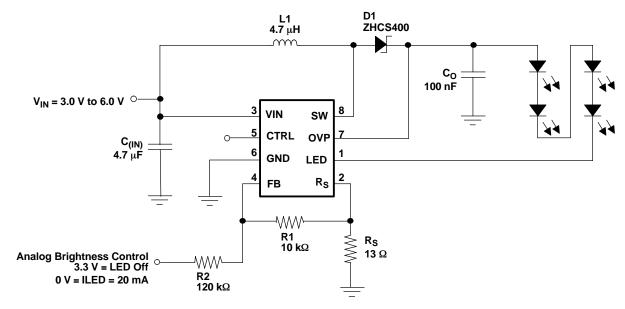


Figure 25. Adjustable Brightness Control Using an Analog Voltage



Application Information (continued)

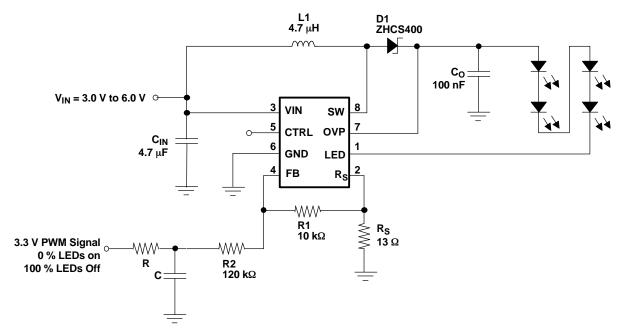
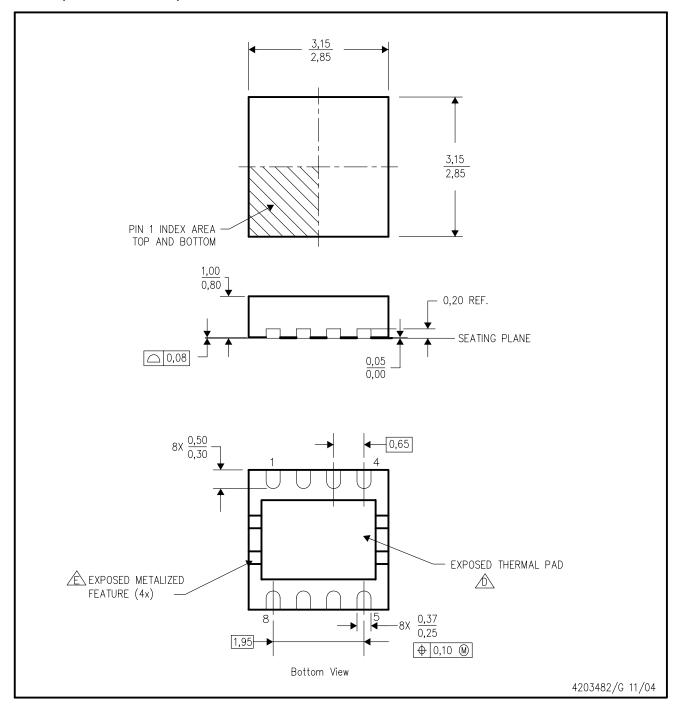


Figure 26. Alternative Adjustable Brightness Control Using PWM Signal

DRB (S-PDSO-N8)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M—1994.
- B. This drawing is subject to change without notice.
- C. Small Outline No-Lead (SON) package configuration.
- The package thermal pad must be soldered to the board for thermal and mechanical performance. See the Product Data Sheet for details regarding the exposed thermal pad dimensions.
- Metalized features are supplier options and may not be on the package.



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